

# FMM6G30US60

## Compact & Complex Module

### General Description

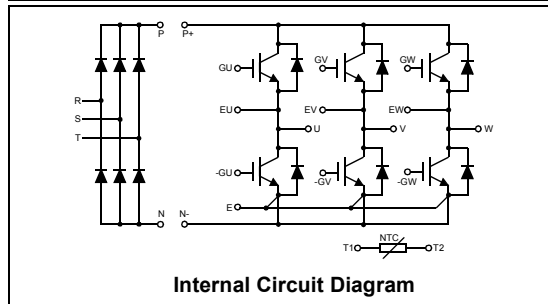
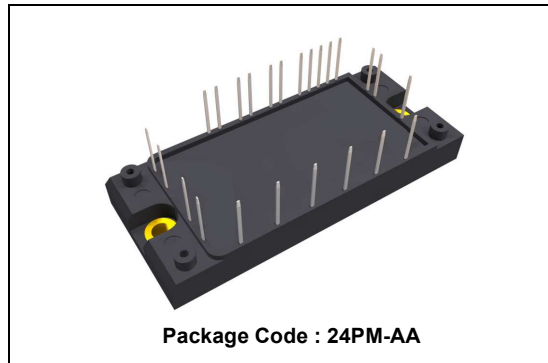
Fairchild IGBT Power Module provides low conduction and switching losses as well as short circuit ruggedness. It's designed for the applications such as motor control and general inverters where short-circuit ruggedness is required.

### Features

- Short Circuit rated Time ; 10us @  $T_C = 100^\circ\text{C}$ ,  $V_{GE} = 15\text{V}$
- High Speed Switching
- Low Saturation Voltage :  $V_{CE(sat)} = 2.1\text{V}$  @  $I_C = 30\text{A}$
- High Input Impedance
- 3 Phase Rectifier Circuit
- Fast & Soft Anti-Parallel FWD
- Built-in NTC Thermistor
- UL Certified No. E209204

### Application

- AC & DC Motor Controls
- General Purpose Inverters
- Robotics
- Servo Controls
- UPS



### Absolute Maximum Ratings $T_C = 25^\circ\text{C}$ unless otherwise noted

	Symbol	Description	FMM6G30US60	Units
Inverter	$V_{CES}$	Collector-Emitter Voltage	600	V
	$V_{GES}$	Gate-Emitter Voltage	$\pm 20$	V
	$I_C$	Collector Current @ $T_C = 80^\circ\text{C}$	30	A
	$I_{CM(1)}$	Pulsed Collector Current	60	A
	$I_F$	Diode Continuous Forward Current @ $T_C = 80^\circ\text{C}$	30	A
	$I_{FM}$	Diode Maximum Forward Current	60	A
	$P_D$	Maximum Power Dissipation @ $T_C = 25^\circ\text{C}$	104	W
Converter	$T_{SC}$	Short Circuit Withstand Time @ $T_C = 100^\circ\text{C}$	10	us
	$V_{RRM}$	Repetitive Peak Reverse Voltage	1600	V
	$I_O$	Average Output Rectified Current	30	A
	$I_{FSM}$	Surge Forward Current @ 1Cycle at 60Hz, Peak value Non-Repetitive	300	A
Common	$I^2t$	Energy pulse @ 1Cycle at 60Hz	369	$\text{A}^2\text{s}$
	$T_J$	Operating Junction Temperature	-40 to +150	$^\circ\text{C}$
	$T_{STG}$	Storage Temperature Range	-40 to +125	$^\circ\text{C}$
	$V_{ISO}$	Isolation Voltage @ AC 1minute	2500	V
Mounting Torque		Mounting part Screw @ M4	4.0	N.m

**Notes :**  
(1) Repetitive rating : Pulse width limited by max. junction temperature

**Electrical Characteristics of IGBT @ Inverter**  $T_C = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
<b>Off Characteristics</b>						
$BV_{CES}$	Collector-Emitter Breakdown Voltage	$V_{GE} = 0V, I_C = 250\mu A$	600	--	--	V
$\Delta BV_{CES}/\Delta T_J$	Temperature Coeff. of Breakdown Voltage	$V_{GE} = 0V, I_C = 1mA$	--	0.6	--	$V/^\circ C$
$I_{CES}$	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0V$	--	--	250	$\mu A$
$I_{GES}$	Gate - Emitter Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0V$	--	--	$\pm 100$	nA

<b>On Characteristics</b>						
$V_{GE(th)}$	Gate - Emitter Threshold Voltage	$I_C = 30mA, V_{CE} = V_{GE}$	5.0	6.5	8.5	V
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C = 30A, V_{GE} = 15V$	--	2.1	2.7	V

<b>Dynamic Characteristics</b>						
$C_{ies}$	Input Capacitance	$V_{CE} = 30V, V_{GE} = 0V,$ $f = 1MHz$	--	2100	--	pF
$C_{oes}$	Output Capacitance		--	270	--	pF
$C_{res}$	Reverse Transfer Capacitance		--	36	--	pF

<b>Switching Characteristics</b>						
$t_{d(on)}$	Turn-On Delay Time	$V_{CC} = 300V, I_C = 30A,$ $R_G = 15\Omega, V_{GE} = 15V,$ Inductive Load, $T_C = 25^\circ C$	--	110	150	ns
$t_r$	Rise Time		--	90	200	ns
$t_{d(off)}$	Turn-Off Delay Time		--	150	200	ns
$t_f$	Fall Time		--	130	250	ns
$E_{on}$	Turn-On Switching Loss		--	0.9	--	mJ
$E_{off}$	Turn-Off Switching Loss	--	0.58	--	mJ	
$t_{d(on)}$	Turn-On Delay Time	$V_{CC} = 300V, I_C = 30A,$ $R_G = 15\Omega, V_{GE} = 15V,$ Inductive Load, $T_C = 125^\circ C$	--	100	150	ns
$t_r$	Rise Time		--	90	200	ns
$t_{d(off)}$	Turn-Off Delay Time		--	150	200	ns
$t_f$	Fall Time		--	200	400	ns
$E_{on}$	Turn-On Switching Loss		--	0.98	--	mJ
$E_{off}$	Turn-Off Switching Loss	--	0.9	--	mJ	
$T_{sc}$	Short Circuit Withstand Time	$V_{CC} = 300V, V_{GE} = 15V$ @ $T_C = 100^\circ C$	10	--	--	us
$Q_g$	Total Gate Charge	$V_{CE} = 300V, I_C = 30A,$ $V_{GE} = 15V$	--	90	150	nC
$Q_{ge}$	Gate-Emitter Charge		--	20	40	nC
$Q_{gc}$	Gate-Collector Charge		--	35	70	nC

**Electrical Characteristics of DIODE @ Inverter**  $T_C = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units	
$V_{FM}$	Diode Forward Voltage	$I_F = 30\text{A}$	$T_C = 25^\circ\text{C}$	--	2.0	2.8	V
			$T_C = 100^\circ\text{C}$	--	2.0	--	
$t_{rr}$	Diode Reverse Recovery Time		$T_C = 25^\circ\text{C}$	--	90	180	ns
			$T_C = 100^\circ\text{C}$	--	130	--	
$I_{rr}$	Diode Peak Reverse Recovery Current	$I_F = 30\text{A}$ $di / dt = 60 \text{ A/us}$	$T_C = 25^\circ\text{C}$	--	2.2	3.4	A
			$T_C = 100^\circ\text{C}$	--	3.4	--	
$Q_{rr}$	Diode Reverse Recovery Charge		$T_C = 25^\circ\text{C}$	--	400	600	nC
			$T_C = 100^\circ\text{C}$	--	880	--	

**Electrical Characteristics of DIODE @ Converter**  $T_C = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units	
$V_{FM}$	Diode Forward Voltage	$I_F = 30\text{A}$	$T_C = 25^\circ\text{C}$	--	1.1	1.5	V
			$T_C = 100^\circ\text{C}$	--	1.0	--	
$I_{RRM}$	Repetitive Reverse Current	$V_R = V_{RRM}$	$T_C = 25^\circ\text{C}$	--	--	8	mA
			$T_C = 100^\circ\text{C}$	--	5	--	

**Thermal Characteristics**

	Symbol	Parameter	Typ.	Max.	Units
Inverter	$R_{\theta JC}$	Junction-to-Case (IGBT Part, per 1/6 Module)	--	1.2	$^\circ\text{C/W}$
	$R_{\theta JC}$	Junction-to-Case (DIODE Part, per 1/6 Module)	--	1.5	$^\circ\text{C/W}$
Converter	$R_{\theta JC}$	Junction-to-Case (DIODE Part, per 1/6 Module)	--	1.3	$^\circ\text{C/W}$
Weight		Weight of Module	210	--	g

**NTC Thermistor Characteristics**

	Symbol	Parameter	Tol.	Typ.	Units
Thermistor	$R_{25}$	Rated Resistance @ $T_c = 25^\circ\text{C}$	+/- 5 %	5.0	$\text{K}\Omega$
	$R_{100}$	Rated Resistance @ $T_c = 100^\circ\text{C}$	+/- 5 %	0.415	$\text{K}\Omega$
	$B_{(25/100)}$	B - Value	+/- 3 %	3692	

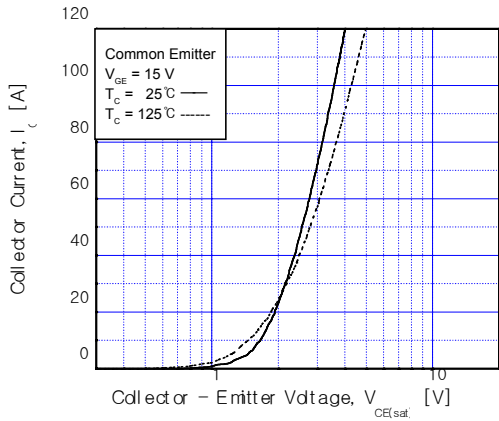


Fig 1. Typical Output Characteristics

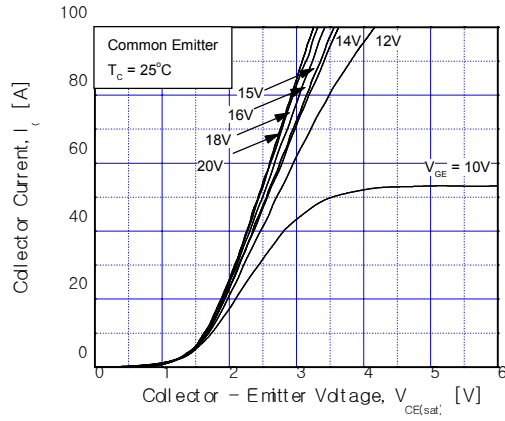


Fig 2. Typical Saturation Voltage Characteristics

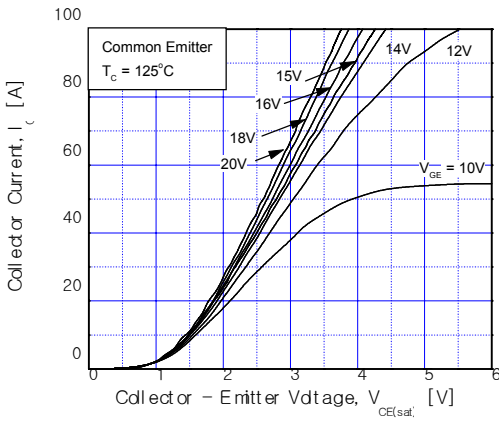


Fig 3. Typical Saturation Voltage Characteristics

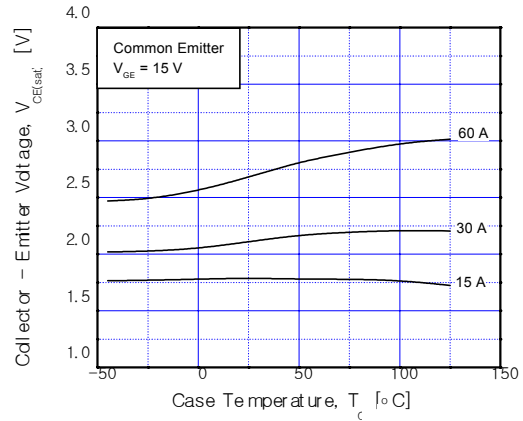


Fig 4. Saturation Voltage vs. Case Temperature at Variant Current Level

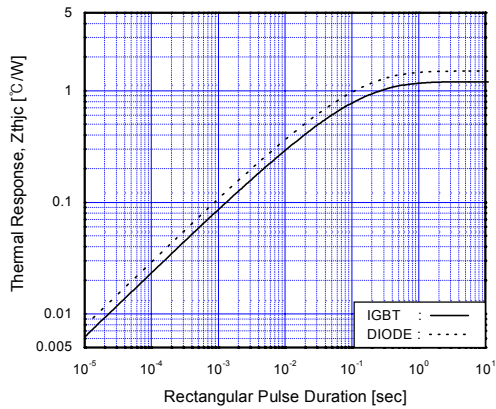


Fig 5. Transient Thermal Impedance

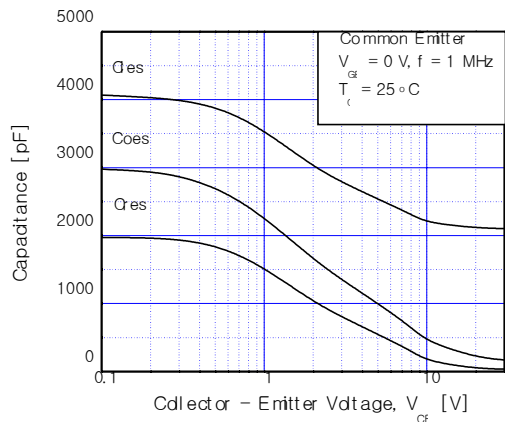


Fig 6. Capacitance Characteristics

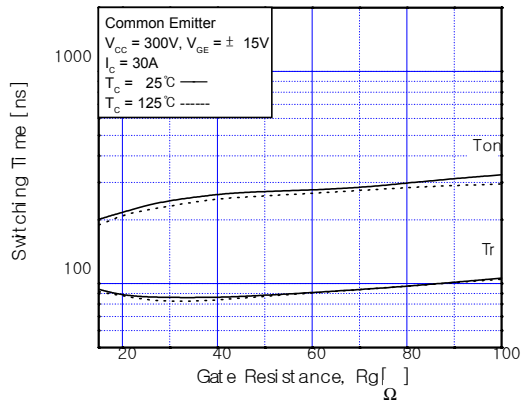


Fig 7. Turn-On Characteristics vs. Gate Resistance

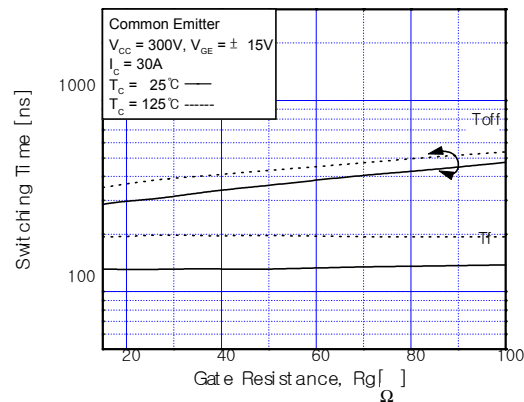


Fig 8. Turn-Off Characteristics vs. Gate Resistance

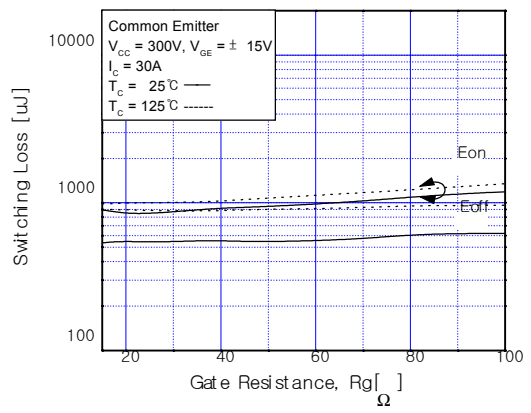


Fig 9. Switching Loss vs. Gate Resistance

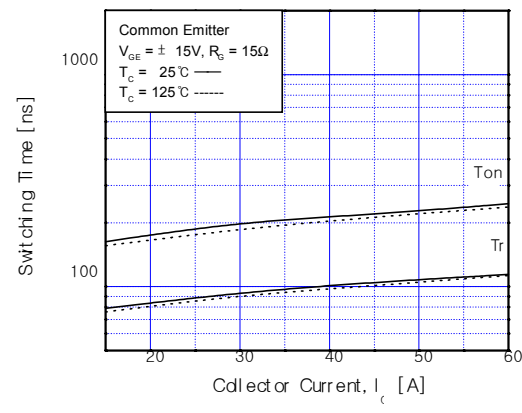


Fig 10. Turn-On Characteristics vs. Collector Current

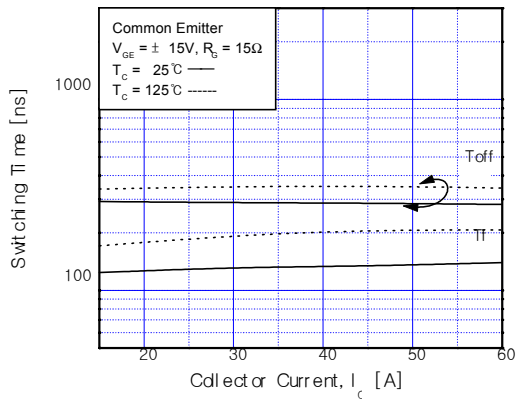


Fig 11. Turn-Off Characteristics vs. Collector Current

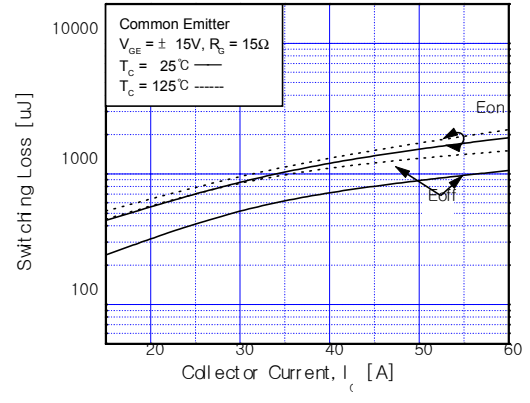


Fig 12. Switching Loss vs. Collector Current

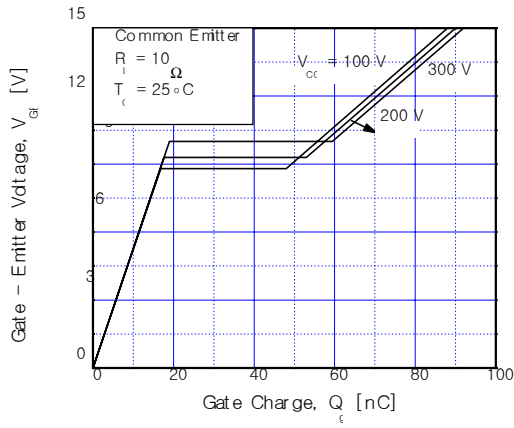


Fig 13. Gate Charge Characteristics

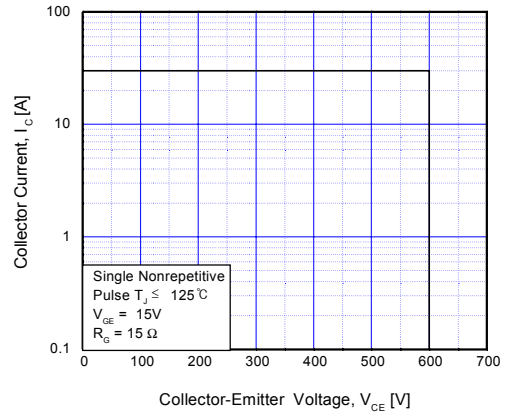


Fig 14. RBSOA Characteristics

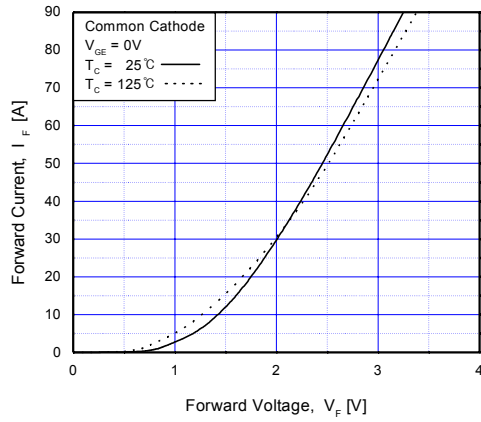


Fig 15. Forward Characteristics

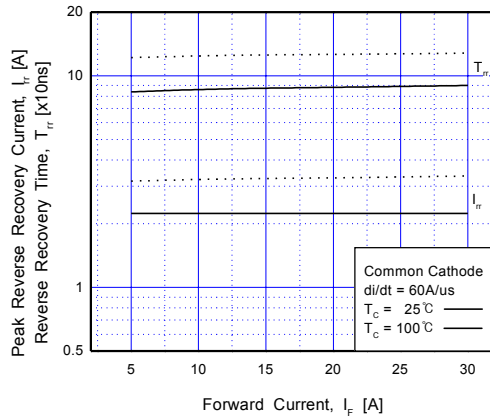


Fig 16. Reverse Recovery Characteristics

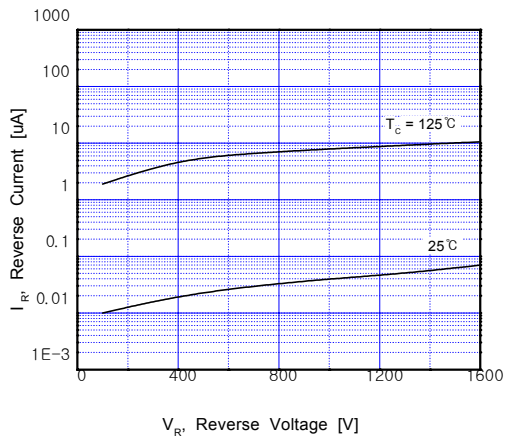


Fig 17. Rectifier ( Converter ) Characteristics

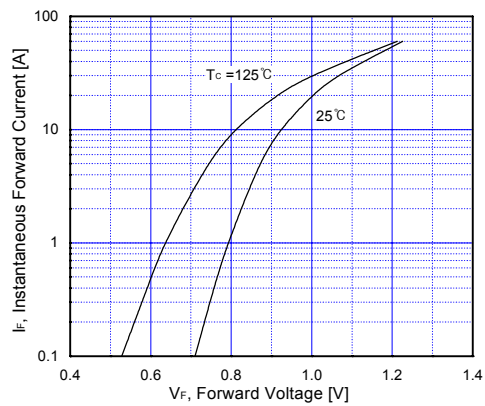


Fig 18. Rectifier ( Converter ) Characteristics

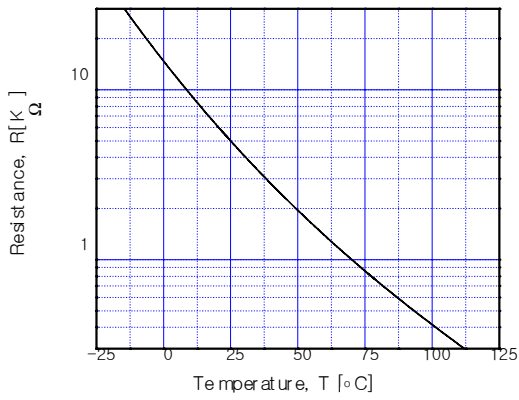


Fig 19. NTC Characteristics

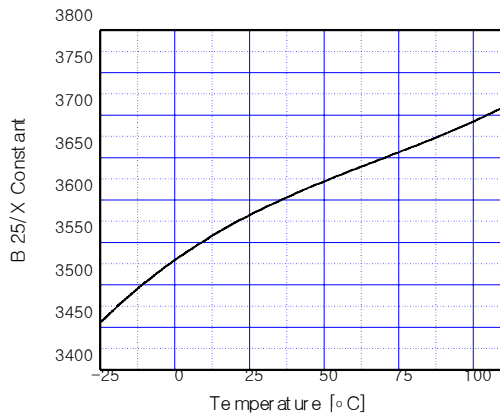
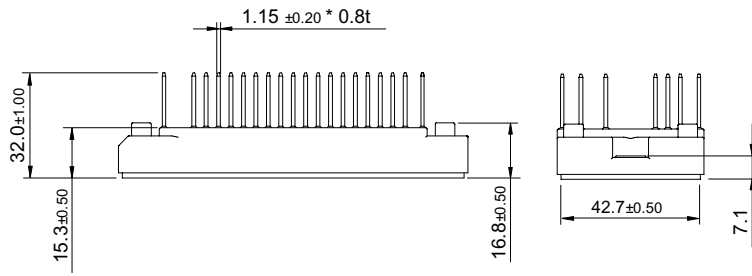
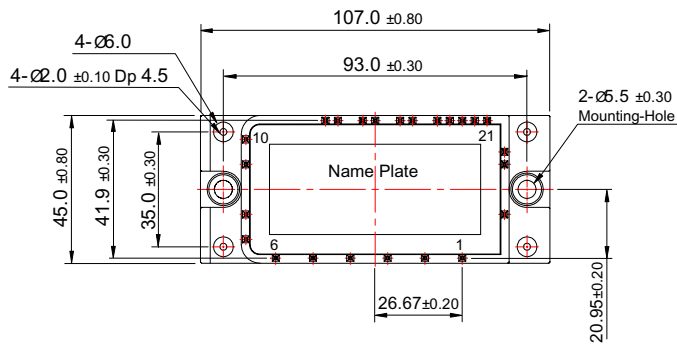


Fig 20. NTC Characteristics

Package Dimension

24PM-AA



- Pin Coordinate

Pin #No	Coordinate	
	x	y
1	0.0	0.0
2	-11.43	0.0
3	-22.86	0.0
4	-34.29	0.0
5	-45.72	0.0
6	-57.15	0.0
7	-66.27	5.71
8	-66.27	13.33
9	-66.27	28.57
10	-66.27	36.19
11	-41.91	41.90
12	-38.10	41.90
13	-30.48	41.90
14	-26.67	41.90
15	-19.05	41.90
16	-15.24	41.90
17	-7.62	41.90
18	-3.81	41.90
19	0.0	41.90
20	3.81	41.90
21	7.62	41.90
22	12.93	32.38
23	12.93	28.57
24	12.93	13.33

- datum pin : #1
- Pin Tilt : ±0.20

Dimensions in Millimeters



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## PRODUCT STATUS DEFINITIONS

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Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
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